

3.2x1.6mm SMD CHIP LED LAMP

APC3216EC HIGH EFFICIENCY RED

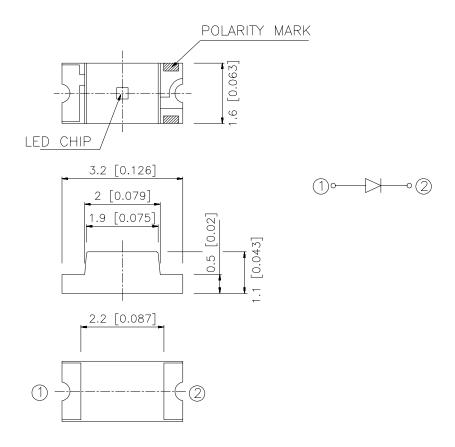
Features

- •3.2mmx1.6mm SMT LED, 1.1mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE: 2000PCS/REEL.

Description

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.0079")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

SPEC NO: DSAD0995 APPROVED : J. Lu REV NO: V.1 CHECKED :Allen Liu DATE:MAR/20/2003 DRAWN:D.L.HUANG PAGE: 1 OF 4



Selection Guide

Part No.	Dice	Lens Type	lv (mcd) @ 20 mA		Viewing Angle
		,.	Min.	Тур.	201/2
APC3216EC	HIGH EFFICIENCY RED(GaAsP/GaP)	WATER CLEAR	4	12	120°

Note:

Electrical / Optical Characteristics at T_A=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	High Efficiency Red	627		nm	I F =20mA
λD	Dominate Wavelength	High Efficiency Red	625		nm	I F =20mA
Δλ1/2	Spectral Line Half-width	High Efficiency Red	45		nm	I F =20mA
С	Capacitance	High Efficiency Red	15		pF	V F=0V;f=1MHz
VF	Forward Voltage	High Efficiency Red	2.0	2.5	V	I F =20mA
IR	Reverse Current	High Efficiency Red		10	uA	V R = 5V

Absolute Maximum Ratings at T_A=25°C

Parameter	High Efficiency Red	Units
Power dissipation	105	mW
DC Forward Current	30	mA
Peak Forward Current [1]	160	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

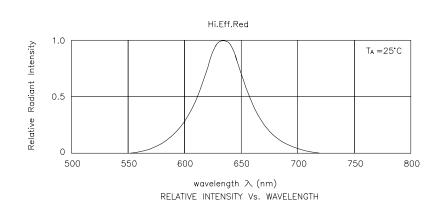
Note

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

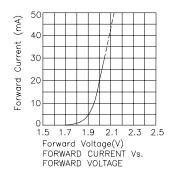
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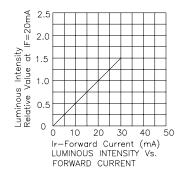
^{1.} θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

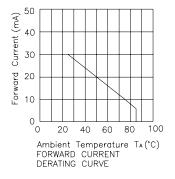
Kingbright

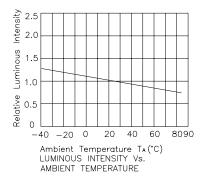


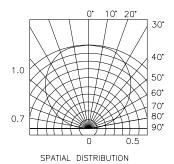
High Efficiency Red APC3216EC











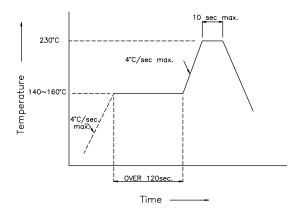
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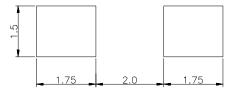
APC3216EC

SMT Reflow Soldering Instructions

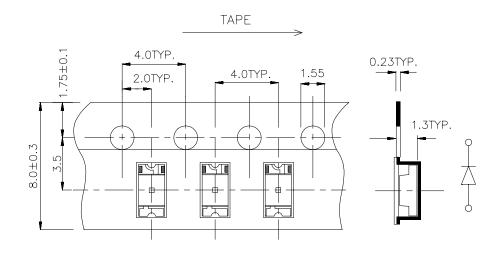
Number of reflow process shall be less than 2 times and cooling process to normal temperature is required between first and second soldering process.



Recommended Soldering Pattern (Units:mm)



Tape Specifications (Units:mm)



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